

September 26, 2003



Mail Stop PATENT APPLICATION
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

16424 U.S. PRO
10/672416
09/26/03

Dear Sir:

Enclosed is a patent application for Disclosure No. 03RSC004, D. Morgan Tench and John T. White, Improved Copper Bath for Electroplating Fine Circuitry on Semiconductor Chips, including:

30 pages of specification, including claims
6 sheets of drawings
Declaration and Power of Attorney
Assignment to Innovative Technology Licensing, LLC

CLAIMS AS FILED									
Basic Fee									750.00
	Filed				Extra		Rate		
Total Claims	33	-	20	=	13	x	18.00	=	234.00
Independent Claims	7	-	3	=	4	x	84.00	=	336.00
Total Filing Fee									= \$1,320.00

Please charge Deposit Account No. 18-1750 in the amount of \$1,320.00 for the filing fee. Please charge Deposit Account No. 18-1750 in the amount of \$40.00 for the assignment recording fee. Charge any additional fees which may be required under 37 CFR 1.16 or credit any overpayment to Deposit Account No. 18-1750.

Respectfully submitted,

John J. Deinken
Attorney for Applicants
Registration No. 28,406
Innovative Technology Licensing, LLC
P.O. Box 1085, Mail Code A15
Thousand Oaks, CA 91358-0085
Telephone: (805) 373-4556
FAX: (805) 373-4672
Email: jdeinken@rwsc.com